## Status of the MSD

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X FOOT Collaboration Meeting – 25-May-2021

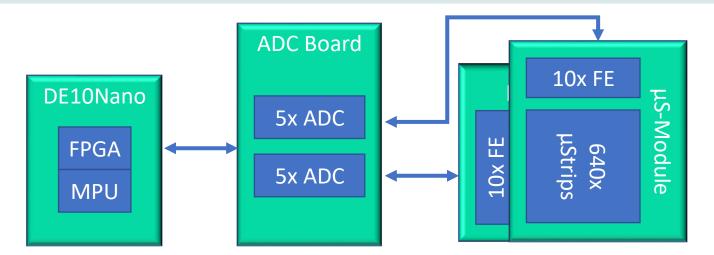




- 1. Recap on the MSD architecture
- 2. Software and gateware status
- 3. Procurement and production status
  - Mechanical assemblies
    - Detector modules
    - DAQ modules (with a focus on the GSI test beam)
  - ADC boards + DE10Nano + MSD Patch Panel
  - µS-Modules
- 4. µS-Module characterizations

## Recap on the MSD Architecture

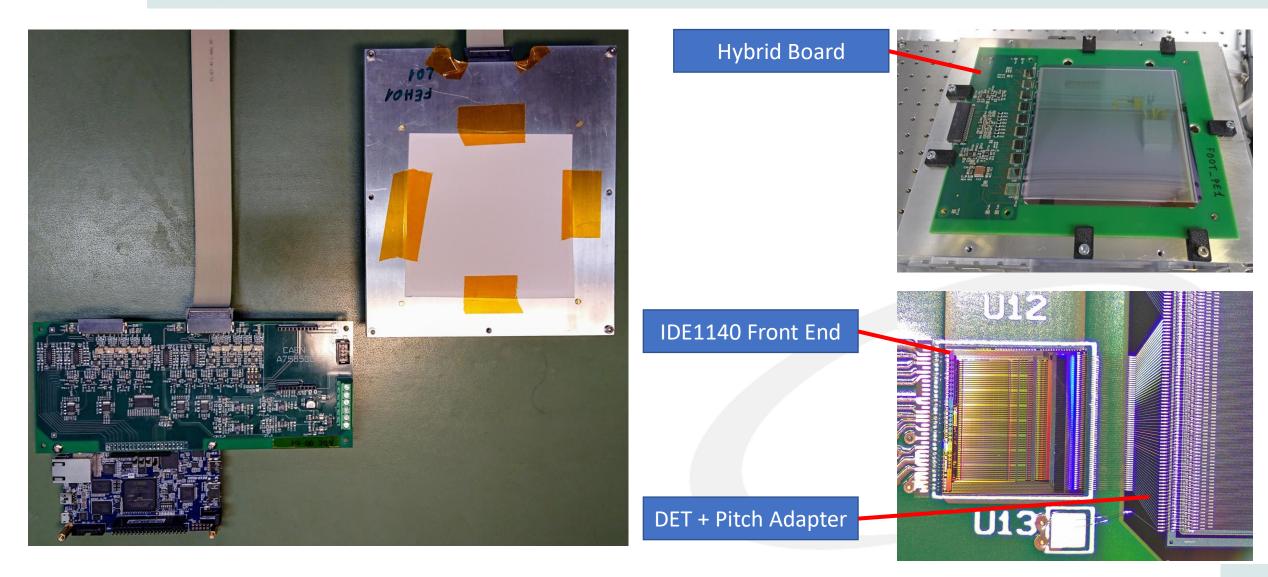
#### Single x-y plane MSD



- 2x <u>µS-Modules</u> (1x x-y plane):
  - 1280 channels and 20x IDE1140 front-ends
    - Strip pitch: 50 µm
    - FE pitch: 150 µm
    - Detector Thickness: 150 µm
- 1x ADC Board: 2x 5x AD7276 ADCs
- 1x DE10Nano: data acquisition

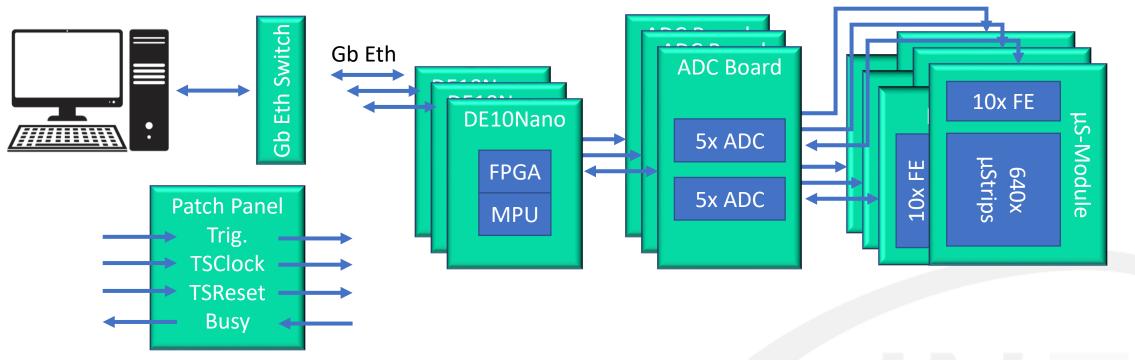
## Recap on the MSD Architecture

#### Single x-y plane MSD



## **INFN** Recap on the MSD Architecture

#### Triple x-y plane MSD



- 3x Single x-y plane MSD
  - Expandable with up to 3 Single x-y plane MSDs
- 1x MSD Patch Panel
  - Fan-out and conversion for Trigger, TSClock, TSReset, Busy
- 1x DAQ PC

# Software and gateware status

### <u>Working standalone version</u> of the DAQ PC software

- pg/standalone branch on the <u>Baltig repository</u> (forked from footpg1\_0.2)
- Simultaneously acquire data from up to 6 ModuleDEMSD

DE10Nano HPS software at the last version

• Issues at auto-loading the FPGA gateware at boot time

DE10Nano FPGA gateware fully integrated with the BO's one

- Moving the project to Baltig and integrating it with Hog (HDL on Gitlab)
  - Add it to the foot group?
- <u>No issues</u> (so far)



Mechanical Assemblies

Consolidate the x-y plane assembly

- Prototype built, found a connectivity issue for the detector connectors
  - Found a fix that we will test in the next days

Building a complete Triple x-y plane MSD

• Based on commercial aluminum structural framing of Bosch Rexroth

Planning the grounding strategy of detector+DAQ

- No radiated emission/susceptibility
- Shielded connectors between µS-Modules and ADC boards

## **INFN** Procurement and production status

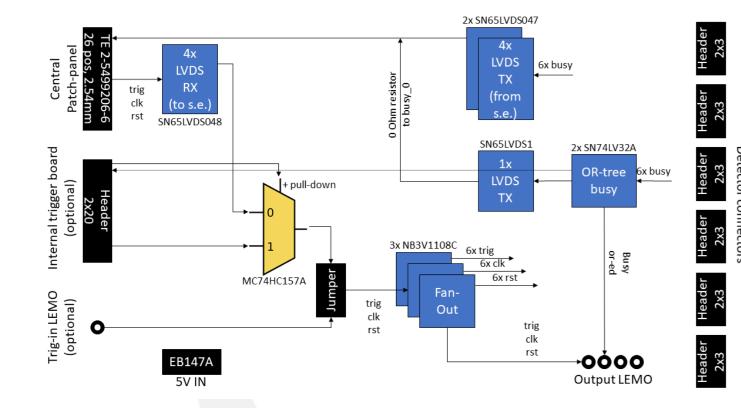
#### ADC boards + DE10Nano + MSD Patch Panel

### In-house

- 5x ADC boards
- 5x DE10Nano
- Internal Cables/Conn.
- Ordered (ETA: Beginning June)
  - 5x MSD Patch Panel
    - Only 1 needed
  - 3x ADC boards
  - 3x DE10Nano
  - Missing Cables/Conn.

## Goal:

 have a <u>complete triple x-y</u> plane MSD plus spares



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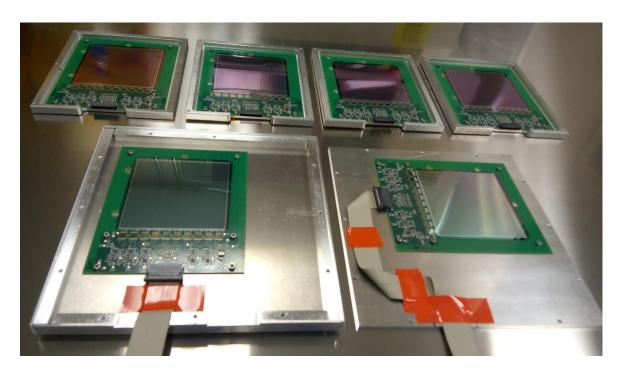
### Procurement and production status INFN

#### µS-Modules

### In-house:

1x Prototype µS-Module

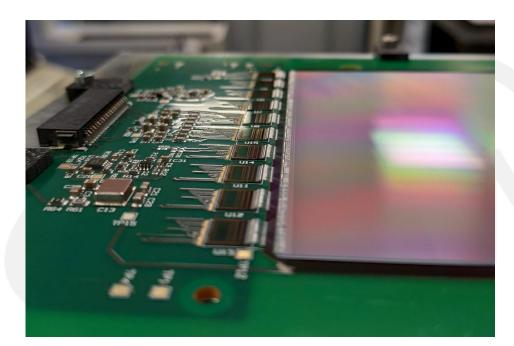
6x Standard µS-Modules (L01...L06)
All tested and characterized with <sup>90</sup>Sr Goal source



Have three complete x-y planes with <u>50% spare</u>

To-be produced:

• 3x µS-Modules





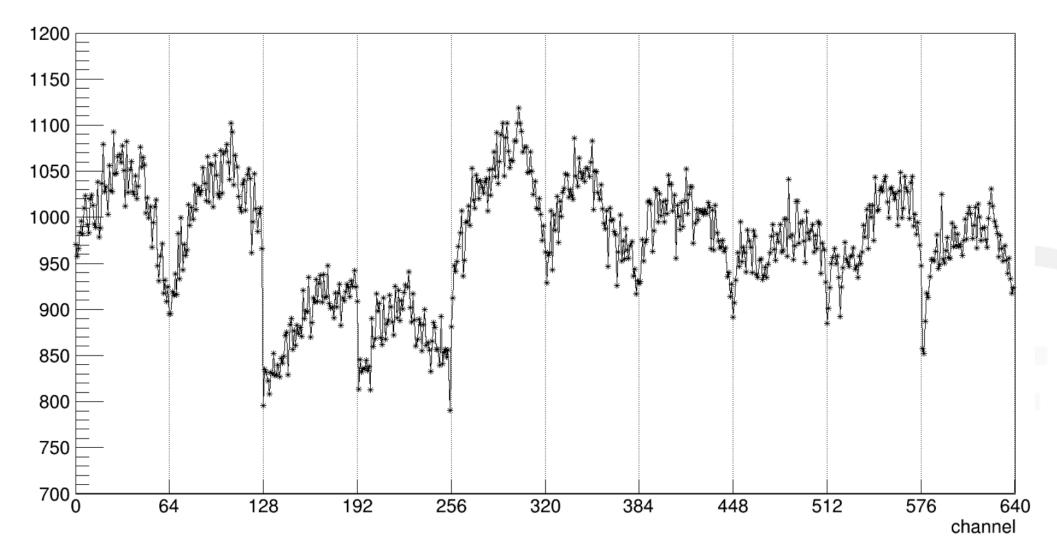
- <u>Characterized each µS-Module</u> with the same DE10Nano and ADC board
- For each µS-Module we performed
  - Calibrations (no rad sources, HV on)
  - Cosmic-ray acquisitions (no rad sources, HV on)
  - <sup>90</sup>Sr acquisitions (rad sources, HV on)

- Cosmic-ray acquisitions comparable to the prototype ones
  - Last FOOT meeting (G. Silvestre)
- Need to replace one ASIC in L02 and L05

| DETECTOR | SIGNAL MPV | RECONSTRUCTED POSITION SIGMA | MEAN # CLUSTER PER EVENT | MEAN # STRIP PER CLUSTER |
|----------|------------|------------------------------|--------------------------|--------------------------|
| L01      | 17.6       | 3.9                          | 1.0                      | 1.7                      |
| L02      | 17.3       | 4.3                          | 1.1                      | 1.7                      |
| L03      | 17.2       | 4.8                          | 1.1                      | 1.8                      |
| L04      | 17.0       | 3.9                          | 1.0                      | 1.8                      |
| L05      | 17.4       | 4.4                          | 1.1                      | 1.7                      |
| L06      | 17.3       | 4.2                          | 1.1                      | 1.8                      |

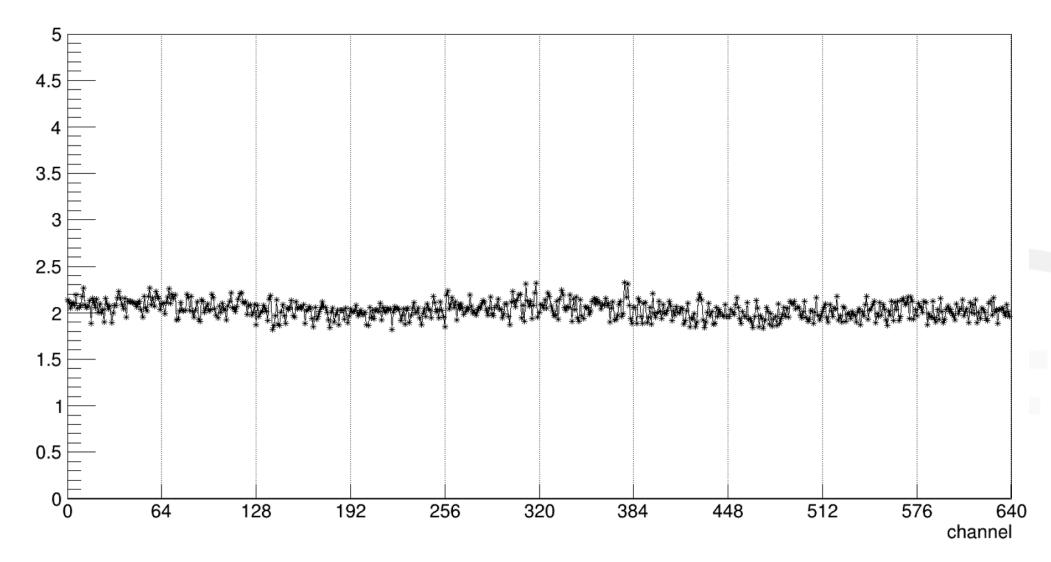


#### Calibrations: L06 Channels Pedestal



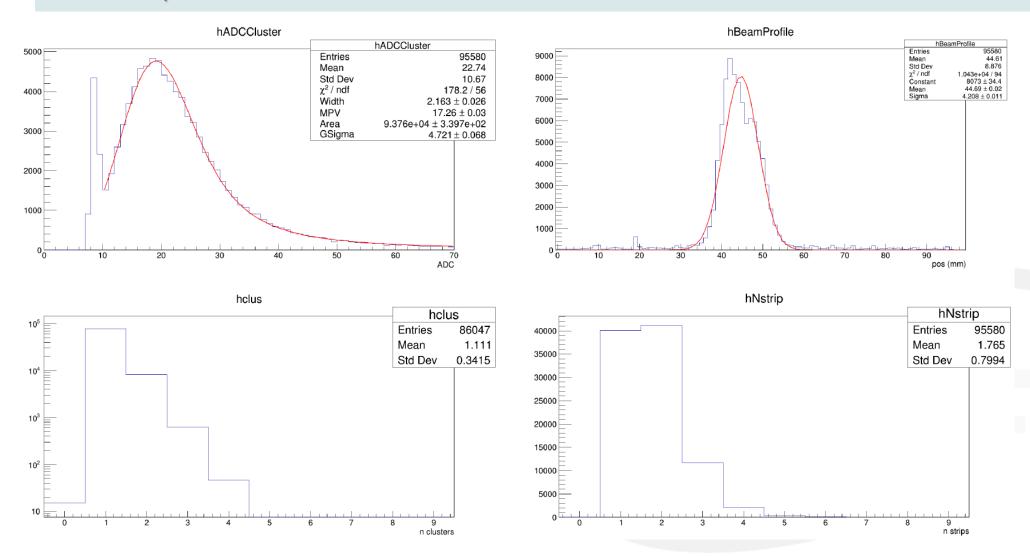
## μS-Module Characterizations

#### Calibrations: L06 Channels Noise (sigma)



## μS-Module Characterizations

<sup>90</sup>Sr Acquisitions





- DAQ SW and GW are stable, with no major issues spotted
  - No issues in acquiring multiple sources
    - 5 kHz maximum trigger rate, with 1 board
- Characterization of single  $\mu$ S-Modules shows consistent results
  - Only two minor issues with ASICs in two modules
- We built the first prototype of the detector mechanical assembly
  - To be tested at the Trento test-beam



- Procurement ongoing
  - 3 additional x-y planes
  - Readout boards
  - MSD Patch Panel
- We shall test the analysis software to be robust with multiple data sources
- Detector+DAQ to be immune to radiated and conducted noise (for the GSI, specifically)
  - Through proper shielding with assemblies

- Proton-beam tests in the near-future
  - Trento: 3-5 June 2021
  - GSI: mid-July 2021
- From these tests we expect
  - Final integration with the general DAQ
  - Hadron calibration of the MSD
  - Verification of the signal characteristics
    - Cluster signal
    - Cluster width
    - Efficiency